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United States Patent [19]

[54] METHOD FOR PLANARIZING A

Japan

May 25, 1993

Foreign Application Priority Data

Field of Search 156/636; 437/228, 966,

3,715,842 2/1973 Tredinnick et al. 51/303

4,671,851 6/1987 Beyer et al. 156/645

References Cited

U.S. PATENT DOCUMENTS

AMORPHOUS LAYER

SEMICONDUCTOR DEVICE HAVING A

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437/960, 225, 101, 637

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[22] Filed:

[30]

[56]

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Sep. 25, 1992 [JP]

Oct. 20, 1992 [JP]

Nov. 30, 1992 [JP]

Dec. 11, 1992 [JP]

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[45] Date of Patent: Aug. 29, 1995

4,735,679	4/1988	Laske	437/62
4,879,258	11/1989	Fisher	437/225
4,910,155	3/1990	Cote et al	437/8
4,940,507	7/1990	Harbarger	156/636
5,036,015	7/1991	Sandhu et al	437/8
5,064,683	11/1991	Poon et al	427/39
5,078,801	1/1992	Malik	437/225
5,084,071	1/1992	Neuadic et al	51/309
5,110,428	5/1992	Prigge et al	204/129.3
5,166,096	11/1992	Cote et al	437/195
5,236,861	8/1993	Otsu	437/67
5,246,884	9/1993	Jaso et al	437/225
5,262,346	11/1993	Bindal et al	156/636
5,272,117	12/1993	Roth et al	437/228

FOREIGN PATENT DOCUMENTS

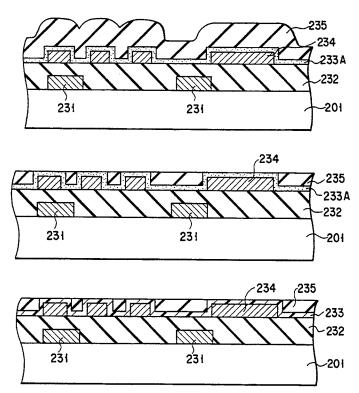
0272531A1 6/1988 European Pat. Off. . 0403287A2 12/1990 European Pat. Off. . 63-266830 11/1988 Japan .

Primary Examiner—Olik Chaudhuri Assistant Examiner—H. Jey Tsai Attorney, Agent, or Firm—Finnegan, Henderson, Farabow, Garrett & Dunner

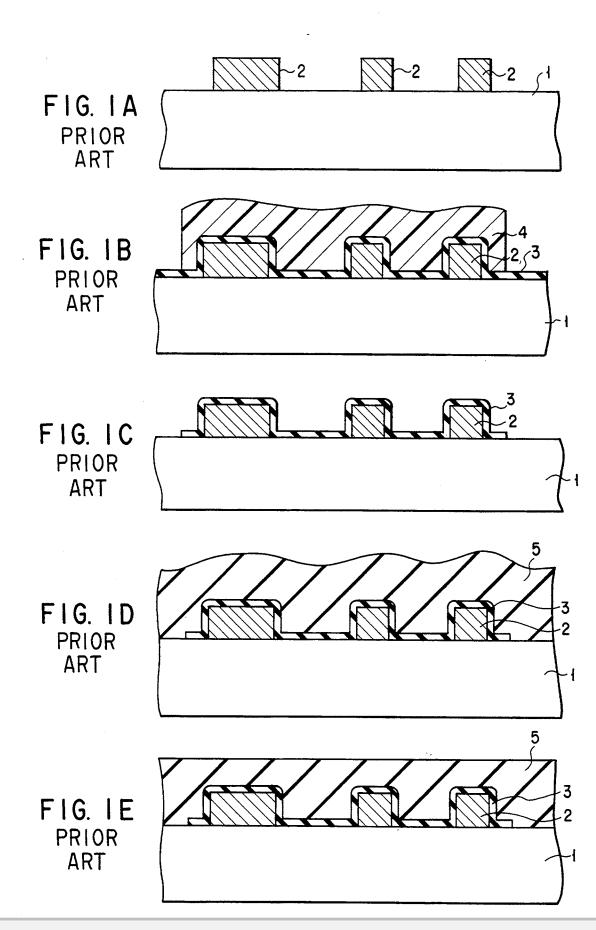
[57] ABSTRACT

To planarize an insulating film formed on a semiconductor substrate, a polishing slurry containing cerium oxide is used to polish the surface of the insulating film. Using the cerium oxide included slurry as a polishing agent, the insulating film is not contaminated by alkali metals during the polishing process. Furthermore, the insulating film is polished at an enhanced polishing rate.

1 Claim, 41 Drawing Sheets







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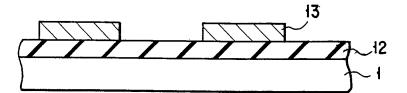
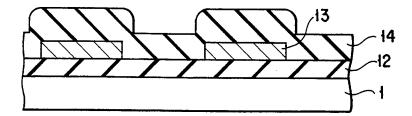
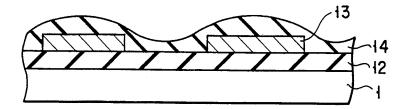
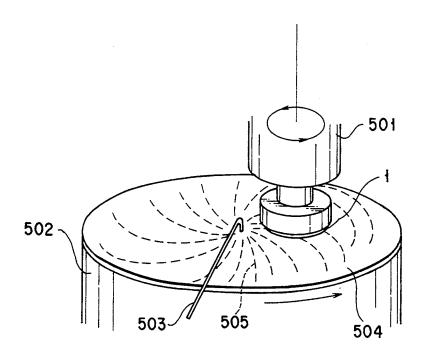


FIG. 2B PRIOR ART

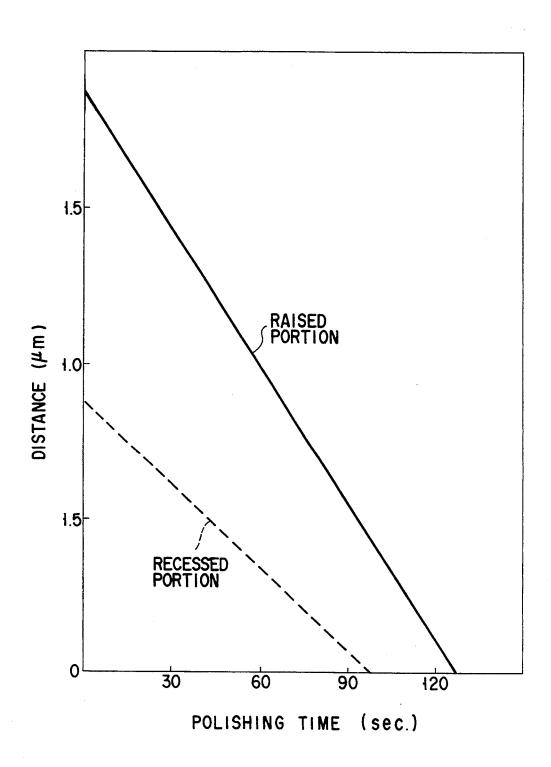


F I G. 2 C PRIOR ART



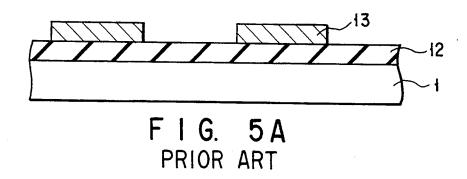


F I G. 3 PRIOR ART

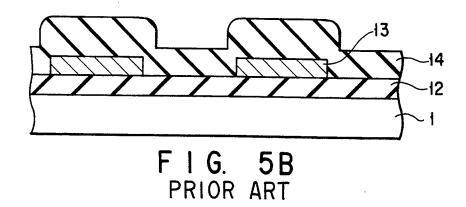


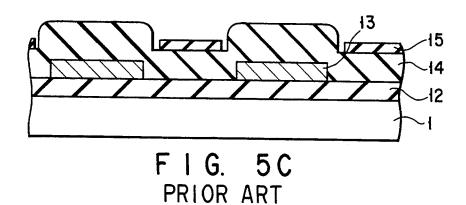
F I G. 4 PRIOR ART

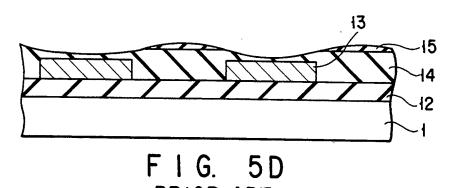




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